DIGIPEN INSTITUTE OF TECHNOLOGY

2008-2009 Alternative Loan Application

1) _____ Print Last Name *(write on line above)*

2) _____ First Name

3) _____ Middle Initial

4) _____ Social Security Number

5) _____ Date of Birth *(mm/dd/yyyy)*

6) Permanent Address _____

7) _____ Permanent Phone Number

8) Address while attending DigiPen _____

9) _____ Local Phone Number

10) Undergraduate *(check one)*

	Fall 2008	Spring 2009
Full time (12+ credits)	☐	☐
Half time (6 - 11 credits)	☐	☐
Less than half time (<6 credits)	☐	☐

11) Graduate *(check one)*

	Fall 2008	Spring 2009
Full time (9+ credits)	☐	☐
Half time (6 - 8 credits)	☐	☐
Less than half time (<6 credits)	☐	☐

12) Are you married? ☐ Yes ☐ No

13) If married, is spouse in school? ☐ Yes ☐ No

14) Do you have any children? ☐ Yes ☐ No

15) Will you have dependent daycare expenses? ☐ Yes ☐ No

16) Will you be receiving any Veterans' benefits while attending DigiPen? ☐ Yes ☐ No

17) While attending DigiPen, I will be: ☐ Living with my parents ☐ Living on my own / with roommate(s)

18) Additional funding for 2008-2009 academic year?

Source/Title	Amount
1)	
2)	
3)	
4)	
5)	

Signature: _____ Date: _____

5001 150th Ave NE | Redmond, WA USA 98052 | Phone (866) 478-5236 | FAX (425) 558-0378 | **www.digipen.edu**